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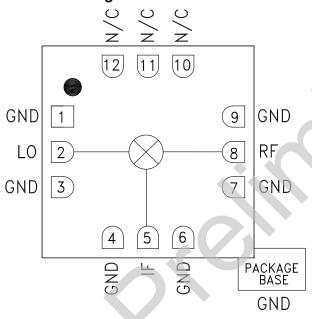
## GaAs MMIC FUNDAMENTAL MIXER, 24 - 32 GHz

#### **Typical Applications**

The HMC329ALC3B is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- Test Equipment & Sensors
- Military End-Use

#### **Functional Diagram**



#### **Features**

Passive: No DC Bias Required

Input IP3: +18 dBm

LO/RF Isolation: 38 dB

Wide IF Bandwidth: DC - 8 GHz

Robust 500V ESD, Class 1B

12 Lead Ceramic 3x3 mm SMT Package: 9mm<sup>2</sup>

#### **General Description**

The HMC329ALC3B is a general purpose double balanced mixer in a leadless RoHS compliant SMT package that can be used as an upconverter or downconverter between 24 and 32 GHz. This mixer requires no external components matching circuitry. or HMC329ALC3B provides excellent LO to RF and LO to IF suppression due to optimized balun Preliminarystructures. The mixer operates with drive levels above +9 dBm. HMC329ALC3B eliminates the need for wire bonding, allowing use of surface mount manufacturing techniques.

### Electrical Specifications, $T_A = +25^{\circ}$ C, IF= 1 GHz, LO= +13 dBm\*

Parameter	Min.	Тур.	Max.	Units
Frequency Range, RF & LO	24 - 32			GHz
Frequency Range, IF	DC - 8			GHz
Conversion Loss		10.5	12.5	dB
Noise Figure (SSB)		10.5	12.5	dB
LO to RF Isolation	32	38		dB
LO to IF Isolation	20	40		dB
RF to IF Isolation	20	30		dB
IP3 (Input)		18		dBm
IP2 (Input)		40		dBm
1 dB Gain Compression (Input)		13		dBm

<sup>\*</sup>Unless otherwise noted, all measurements performed as downconverter, IF= 1 GHz.

# HMC329ALC3B\* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

# COMPARABLE PARTS 🖵

View a parametric search of comparable parts.

## **DOCUMENTATION**

#### **Data Sheet**

 HMC329ALC3B: GaAs MMIC FUNDAMENTAL MIXER, 24 -32 GHz Data Sheet

## DESIGN RESOURCES 🖵

- HMC329ALC3B Material Declaration
- · PCN-PDN Information
- · Quality And Reliability
- · Symbols and Footprints

## **DISCUSSIONS**

View all HMC329ALC3B EngineerZone Discussions.

### SAMPLE AND BUY 🖵

Visit the product page to see pricing options.

### TECHNICAL SUPPORT 🖳

Submit a technical question or find your regional support number.

### DOCUMENT FEEDBACK 🖳

Submit feedback for this data sheet.



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## GaAs MMIC FUNDAMENTAL MIXER, 24 - 32 GHz

#### **Absolute Maximum Ratings**

RF / IF Input	+13 dBm	
LO Drive	+27 dBm	
Channel Temperature	150 °C	
Continuous Pdiss (Ta = 85 °C) (derate 5.88 mW/°C above 85 °C)	382 mW	
Thermal Resistance (junction to ground paddle)	170 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
ESD Sensitivity (HBM)	Class 1B	

#### **MxN Spurious Outputs**

	nLO							
mRF	0	1	2	3	4			
0	xx	9	xx	xx	xx			
1	20	0	42	xx	xx			
2	xx	72	58	80	xx			
3	xx	xx	98	70	90			
4	xx	xx	xx	100	104			

RF = 28 GHz @ -10 dBm LO = 27 GHz @ +13 dBm

All values in dBc below the IF output power level.



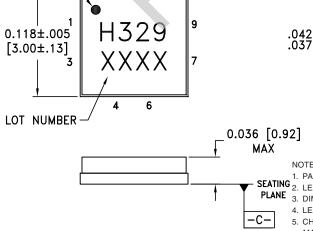
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### **Outline Drawing**

PIN 1



### 

BOTTOM VIEW

1. PACKAGE BODY MATERIAL: ALUMINA.

- SEATING 2. LEAD AND GROUND PADDLE PLATING: GOLD FLASH OVER NICKEL.
- PLANE 3. DIMENSIONS ARE IN INCHES (MILLIMETERS).
  - 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
  - 5. CHARACTERS TO BE HELVETICA MEDIUM, .025 HIGH, BLACK INK, OR LASER MARK LOCATED APPROX. AS SHOWN.
  - 6. PACKAGE WARP SHALL NOT EXCEED 0.05MM DATUM C -
  - 7. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.